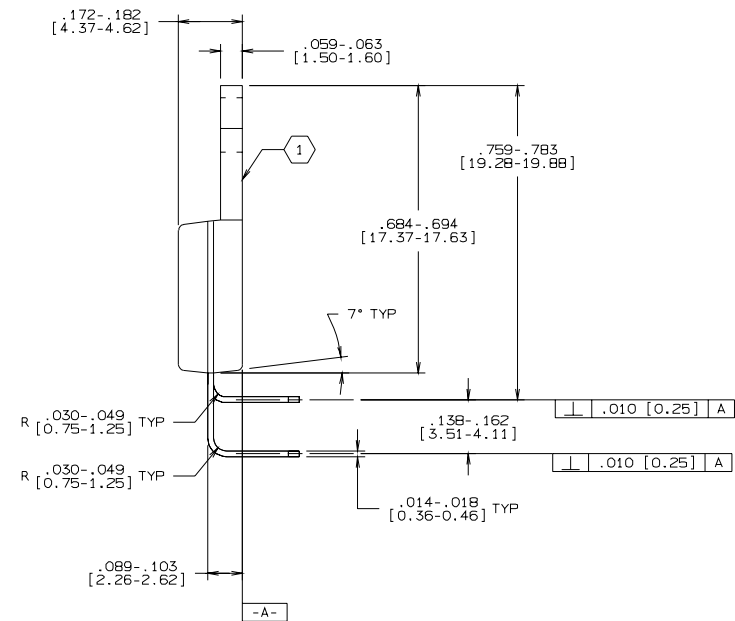
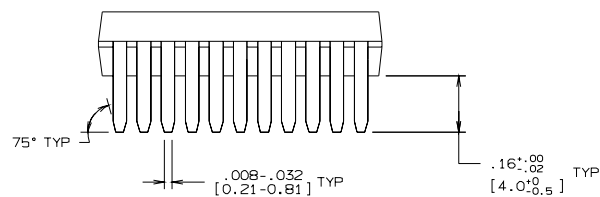
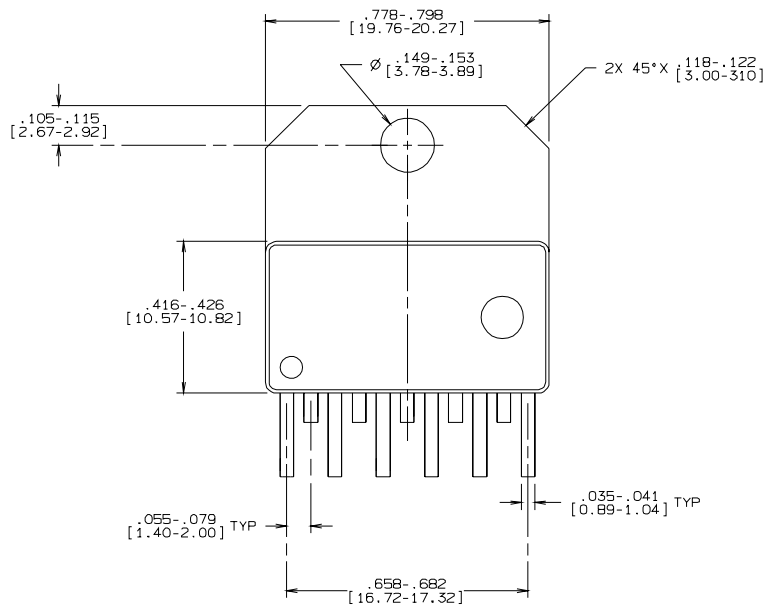


REVISIONS			
LTR	DESCRIPTION	E.C.N.	DATE
A	RELEASE TO DOCUMENT CONTROL	08643	06/24/91



NOTES: UNLESS OTHERWISE SPECIFIED

1. MAXIMUM RELIEF 0.0635 MILLIMETERS/.0025 INCHES.
2. STANDARD LEAD FINISH:
200 MICROINCHES / 5.08 MICROMETERS MINIMUM LEAD/TIN
(SOLDER) ON COPPER.

CONTROLLING DIMENSION: MILLIMETER			
APPROVALS	DATE	 NATIONAL SEMICONDUCTOR CORPORATION 2900 Semiconductor Drive, Santa Clara, CA 95052-8090	
DRAWN	D.E. GRADY		
DFTG. CHK.			
ENGR. CHK.			
APPROVAL		TO-220, MOLDED, 11 LEAD, 90° STAGGERED	
 PROJECTION INCH [MM]		SCALE	SIZE
		N/A	C
		DRAWING NUMBER	REV
		MKT-TAO11E	A
		DO NOT SCALE DRAWING	SHEET 1 OF 1